



Click [here](#) for the 3D model.

General Information

| | |
|----------------|------------------------------|
| Series | MPXV |
| Style | SMD Molded |
| Core | Metal Composite |
| Description | Surface Mount Inductor |
| Features | Power Inductors |
| RoHS | Yes |
| Qualifications | AEC-Q200 |
| AEC-Q200 | Yes |
| Miscellaneous | 40 (K) Temperature Rise Max. |

Dimensions

| | |
|-----------|-----------------|
| Chip Size | 1235(5350) |
| L | 13.2mm +/-0.4mm |
| W | 12.5mm +/-0.2mm |
| T | 3.5mm MAX |
| G | 3mm +/-0.3mm |

Packaging Specifications

| | |
|--------------------------|------------|
| Typical Component Weight | 2.9 g |
| Packaging | T&R, 330mm |
| Packaging Quantity | 500 |

Specifications

| | |
|-------------------------|---|
| Inductance | 2.2 uH (100 kHz) |
| Inductance Tolerance | 20% |
| Inductance | 2200 nH |
| Rated Current | 15.2 A (Irms, 40C Rise By Self Heating) |
| Saturation Current | 15.5 A (Isat, 20% Drop In Inductance), 23 A (Isat, 30% Drop In Inductance) |
| Temperature Range | -55/+155°C |
| Shielded | true |
| Current | 15.2 A (Irms, 40C Rise By Self Heating), 15.5 A (Isat, 20% Drop In Inductance), 23 A (Isat, 30% Drop In Inductance) |
| DC Resistance | 8.4 mOhms |
| DC Resistance | 8.4 mOhms |
| Self-Resonant Frequency | 21 MHz |

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